



TEST RESULT SUMMARY

Project No.: 1-6851/13-01-02

Test Laboratory

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Applicant

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Manufacturer

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Test Standards

NFC Forum Test Cases for DP, v1.0.04 NFC Forum Test Cases for Digital Protocol – 1st Wave of Certification, Version 1.0.04
 NFC Forum TCCL, v1.4 NFC Forum Test Case Category List, Version 1.4

Test Item

Kind of test item: **NFC Forum Tag (Type 4B)**
Model name: **RF430CL330**
 S/N serial number: 1210013410
 HW hardware status: Rev. D / V1.3

Summary of Measurement Results

<input checked="" type="checkbox"/>	No deviations from the technical specifications were ascertained
<input type="checkbox"/>	There were deviations from the technical specifications ascertained

Note: The test amount was limited to Listen Mode tests for type NFC-B as the DUT doesn't support further modes of operation.

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